

Department of Information Technology and Electrical Engineering

NAVOLCHI WP6 Integration, Characterization & Testing

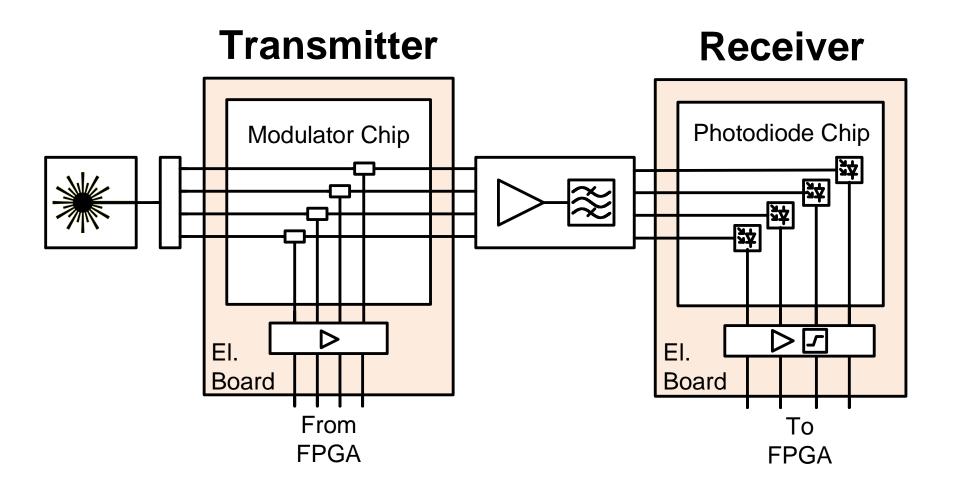
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Institute of Electromagnetic Fields (IFH)



Demonstrator





Transmitter Packaging – Electrical Board and Housing

- K-connectors
- Impedance matching
- DC Bias to determine operating point
- Passive cooling: copper block below
- 32 Gbit/s, 3…9 V_{pp}

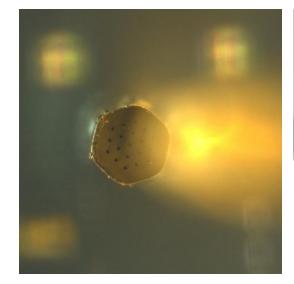
Fabrication almost finished, to be characterized

Space for photonic chip



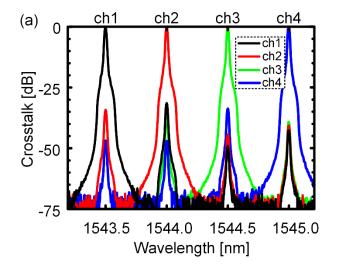
Optical Link – Multicore Fiber

Chiral Photonics (PROFA)





- 4 out of 19 channels with 50 μm pitch
- Crosstalk measured to be below -31 dB
- Less than 1 dB worse transmission compared to normal fibers
- Allows for optical amplifier between transmitter and receiver





Receiver - Electronics

- Gigoptix HXR6204 or HXR8204
- 4 channel 28 Gb/s transimpedance limiting amplifier array
- Pad distance 250 µm

To be assemblied with IMEC PDs